# PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date	
MR. Sumer Johal	06/05/2006	

## **RECEIVING PARTY DATA**

Name:	Pivotal Systems Corporation			
Street Address:	4637 Chabot Drive			
City:	Pleasanton			
State/Country:	CALIFORNIA			
Postal Code:	94588			

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11335099

## **CORRESPONDENCE DATA**

Fax Number: (408)884-2357

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

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NAME OF SUBMITTER: Michael W. Caldwell

Total Attachments: 2

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\$40.00 1

PATENT REEL: 017854 FRAME: 0059

# **ASSIGNMENT**

For good and valuable consideration, the receipt of which is hereby acknowledged, the person(s) named below (referred to as "INVENTOR" whether singular or plural) has sold, assigned, and transferred and does hereby sell, assign, and transfer to **Pivotal Systems Corporation**, a Delaware corporation, having a place of business at 4637 Chabot Drive, Pleasanton, CA 94588, ("ASSIGNEE"), for itself and its successors, transferees, and assignees, the following:

improveme	ents ("SUBJE	CT M	ATTER	") that are	disclosed in	n the	provision	al applica	tion
filed under	r 35 U.S.C.	§111(t	o) or n	o <mark>n-pr</mark> ovisio	nal applica	ition	filed und	er 35 U.S	S.C.
§111(a) a	nd entitled	End	Point	Detection	Method	for	Plasma	Etching	of
Semiconductor Wafers with Low Exposed Area ("APPLICATION"), which:									
	is to be filed	l herew	ith.						
$\boxtimes$	was filed on	Januai	y 18, 2	006, and no	w bears U.	S. app	olication s	erial numl	oer
	11/335,099.								

The entire worldwide right, title, and interest in all inventions and

- The APPLICATION claims priority from a provisional application, filed on January 19, 2005, now bearing U.S. application serial number 60/644,928.
- 2. The entire worldwide right, title, and interest in and to:
- (a) the APPLICATION; (b) all applications claiming priority from the APPLICATION; (c) all provisional, utility, divisional, continuation, substitute, renewal, reissue, and other applications related thereto which have been or may be filed in the United States or elsewhere in the world; (d) all patents (including reissues and re-examinations) which may be granted on the applications set forth in (a), (b), and (c) above; and (e) all right of priority in the APPLICATION and in any underlying provisional or foreign application, together with all rights to recover damages for infringement of provisional rights.

INVENTOR agrees that ASSIGNEE may apply for and receive patents for SUBJECT MATTER in ASSIGNEE's own name.

INVENTOR agrees to do the following, when requested, and without further consideration, in order to carry out the intent of this Assignment: (1) execute all oaths, assignments, powers of attorney, applications, and other papers necessary or desirable to fully secure to ASSIGNEE the rights, titles and interests herein conveyed; (2) communicate to ASSIGNEE all known facts relating to the SUBJECT MATTER; and (3) generally do all lawful acts that ASSIGNEE shall consider desirable for securing, maintaining, and enforcing worldwide patent protection relating to the SUBJECT MATTER and for vesting in ASSIGNEE the rights, titles, and interests herein conveyed. INVENTOR further agrees to provide any successor, assign, or legal representative of ASSIGNEE with the benefits and assistance provided to ASSIGNEE hereunder.

INVENTOR represents that INVENTOR has the rights, titles, and interests to convey as set forth herein, and covenants with ASSIGNEE that the INVENTOR has not made and will not hereafter make any assignment, grant, mortgage, license, or other agreement affecting the rights, titles, and interests herein conveyed.

Title:

End Point Detection Method for Plasma Etching of Semiconductor

Wafers with Low Exposed Area

Filed:

January 18, 2006

Application No.:

11/335,099

INVENTOR grants the attorney of record the power to insert on this Assignment any further identification that may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

This Assignment may be executed in one or more counterparts, each of which shall be deemed an original and all of which may be taken together as one and the same Assignment.

Name and Signature

Date of Signature

State of Cali County of

before me, haura 2010 personally appeared [NOTARY PUBLIC]

SUMER JOHAL, personally known to me or proved to me on the basis of satisfactory evidence to be the person whose name is subscribed to the within instrument and acknowledged to me that he/she executed the same in his/her authorized capacity, and that by his/her signature on the instrument the person, or the entity upon behalf of which the person acted, executed the instrument.

LAURA ZARAGOZA Commission # 1527167 Notary Public - California Contra Costa County My Comm. Expires Nov 16, 2008

RECORDED: 06/29/2006

Notary